

#### **P-Channel MOSFET**

## **General Description**

The WST2335A is the highest performance trench P-Channel MOSFET with extreme high cell density , which provide excellent  $R_{DS(ON)}$  and gate charge for most of the small power switching and load switch applications.

The WST2335A meet the RoHS and Green Product requirement with full function reliability approved.

## Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

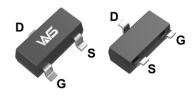
## **Product Summery**

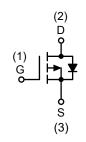
BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>
-20V	35mΩ	-5.8A

#### Applications

- High Frequency Point-of-Load Synchronous Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch







## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage -20		V	
V <sub>GS</sub>	Gate-Source Voltage	±8		
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ -4.5V $^{1}$	-5.8		
I <sub>D</sub> @T <sub>C</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup>	-3.7	A	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	-18.1		
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>3</sup>	1	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range	-55 to 150		

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Units
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient <sup>1</sup>	125	°C/W	
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case <sup>1</sup>		80	C/W



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## Electrical Characteristics (T<sub>J</sub>=25°C, Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250µA	-20			V
$\Delta BV_{DSS}/\Delta T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =-1mA		-0.01		V/°C
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-4A		35	45	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-2.5V , I <sub>D</sub> =-2A		45	57	mΩ
		V <sub>GS</sub> =-1.8V , I <sub>D</sub> =-1.5A		85	105	
V <sub>GS(th)</sub>	Gate Threshold Voltage	- V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250µA	-0.3	-0.5	-1.0	V
$\Delta V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	- ν <sub>GS</sub> -ν <sub>DS</sub> , Ι <sub>D</sub> 250μΑ		2.96		mV/°C
		$V_{DS}$ =-16V , $V_{GS}$ =0V , $T_{J}$ =25°C			-1.0	μΑ
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =-16V , $V_{GS}$ =0V , $T_{J}$ =55°C			-5.0	
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±100	nA
9 <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-4A		21		S
Qg	Total Gate Charge (-4.5V)			27.3	38.2	
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =-15V,V <sub>GS</sub> =-4.5V,I <sub>D</sub> =-4A		3.6	5.0	nC
Q <sub>gd</sub>	Gate-Drain Charge			6.5	9.1	
T <sub>d(on)</sub>	Turn-On Delay Time			9.2	18.4	
T <sub>r</sub>	Rise Time	V <sub>DD</sub> =-10V,V <sub>GS</sub> =-4.5V,		59	106	
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =3.3Ω , I <sub>D</sub> =-4Α		99	198	ns
T <sub>f</sub>	Fall Time			71	142	
C <sub>iss</sub>	Input Capacitance			1025	1120	
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , <i>f</i> =1.0MHz		220	308	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			187	262	

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
ا <sub>S</sub>	Continuous Source Current <sup>1,4</sup>	(-1)			-4.7	Α
I <sub>SM</sub>	Pulsed Source Curren <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V,Force Current			-18.1	A
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V, I <sub>S</sub> =-1A,T <sub>J</sub> =25°C			-1.0	V
t <sub>rr</sub>	Reverse Recovery Time	- I <sub>F</sub> =-4A , dl/dt=100A/µs , T <sub>J</sub> =25°C		52		nS
Q <sub>rr</sub>	Reverse Recovery Charge	<sup>-</sup> ι <sub>F</sub> 4Α, αι/αι-100Α/μS, 1 <sub>J</sub> -25 C		28		nC

Note:

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper, t≤10sec.

2. The data tested by pulsed, pulse width  $\leq 300 \mu s$  , duty cycle  $\leq 2\%.$ 

3. The power dissipation is limited by 150°C junction temperature.

4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



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## **Typical Characteristics**

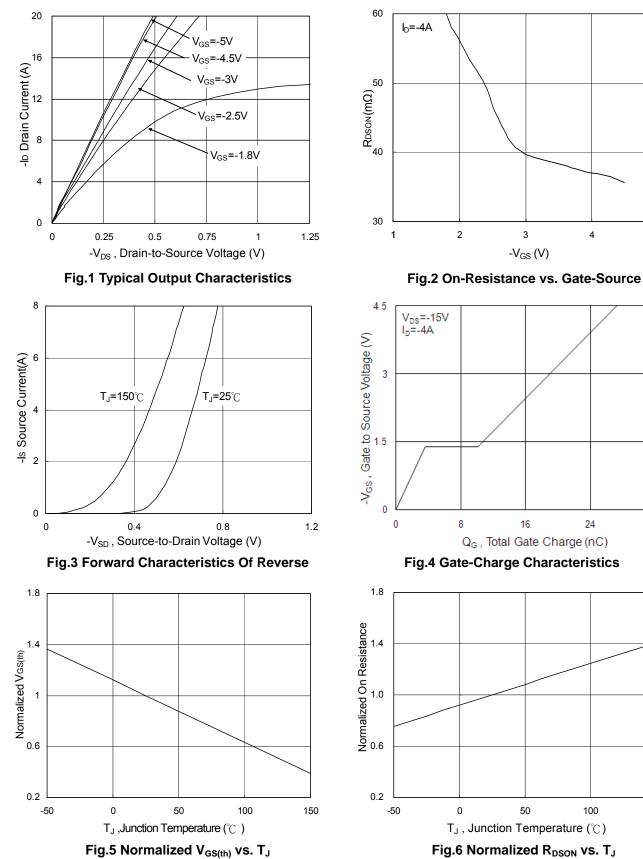


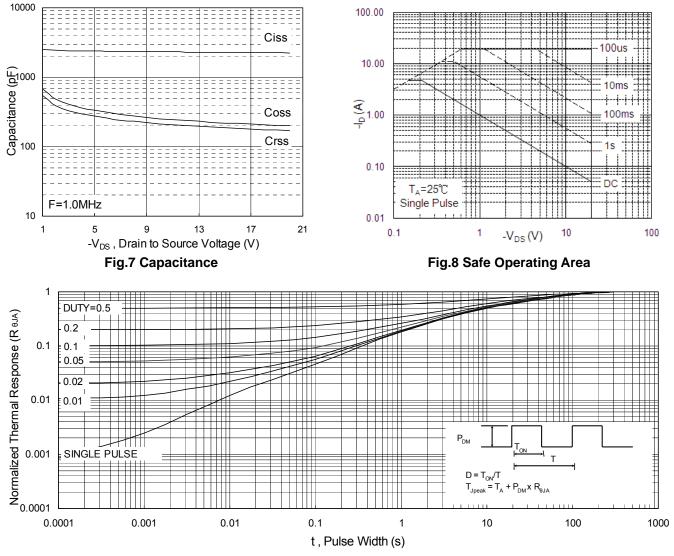
Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

150

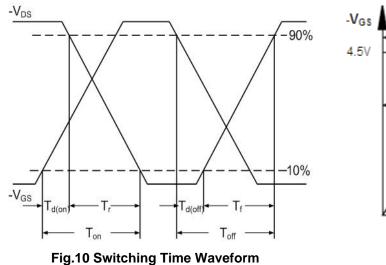


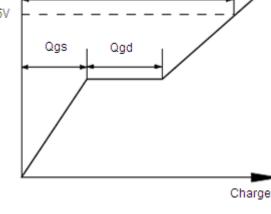
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## **Typical Characteristics (Cont.)**









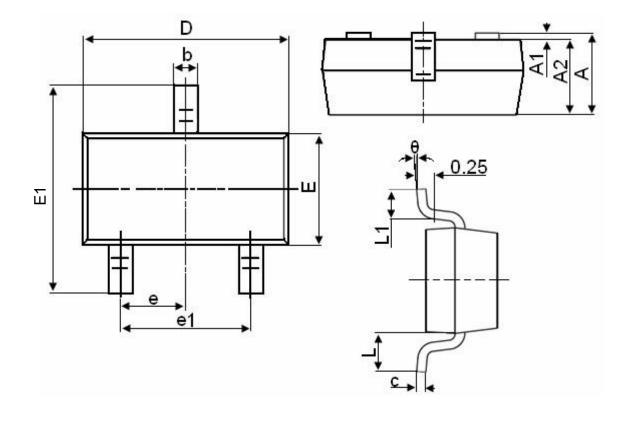
Qg

Fig.11 Gate Charge Waveform



P-Channel MOSFET

# Packaging information



Cumhal	Dimensions in Millimeters			
Symbol	MIN.	MAX.		
А	0.900	1.150		
A1	0.000	0.100		
A2	0.900	1.050		
b	0.300	0.500		
С	0.080	0.150		
D	2.800	3.000		
E	1.200	1.400		
E1	2.250	2.550		
е	0.95	0.950TYP		
e1	1.800	2.000		
L	0.550REF			
L1	0.300	0.500		
θ	0°	8°		



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